Performance Study of Neutron Irradiated HV-MAPS

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14th Hiroshima Symposium, Taipei

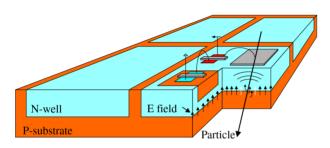
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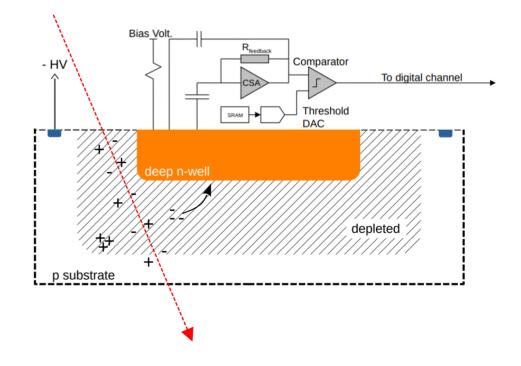


High-Voltage Monolithic Active Pixel Sensors



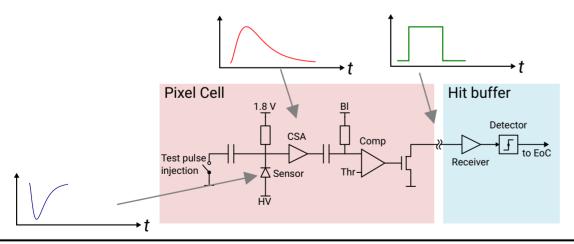
[I Peric, NIM A 582 (2007) 876]

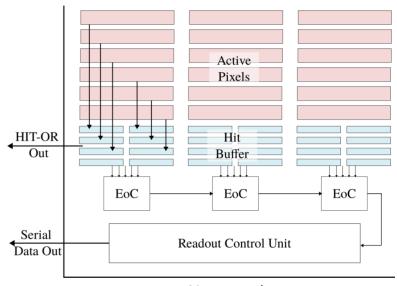
- Commerical HV-CMOS processes
- Large fill factor deep n-well diodes
- Reverse high voltage bias from top side
- Charge collection via drift
- Sensor thickness can be thinned down to 50 μm



High-Voltage Monolithic Active Pixel Sensors

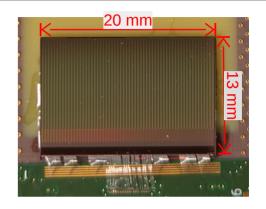
- In pixel electronics
 - Charge sensitive amplifier
 - Tuneable comparator
- Digitisation in hit buffers in periphery
- Column drain readout architecture

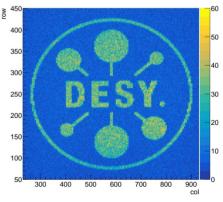




Not to scale

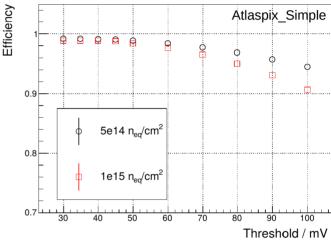
- TSI 180 nm HV-CMOS process
- 200 400 Ωcm Cz p-substrate
- Reverse HV-bias up to ~140 V \rightarrow ≈ 70 µm depletion zone
- 120 × 400 pixels with size 165 × 25 μ m²
- Designed as a fast timing and triggering plane for beam telescopes:
 - Configurable trigger output (analogue Hit-OR)
 - 4 ns Time-of-Arrival sampling
 - 8 ns Time-over-Threshold sampling
 - Hit driven readout at 1.25 Gbit/s
- In operation as user infrastructure at DESY test beam





Hits triggered by TelePix2's Hit-OR

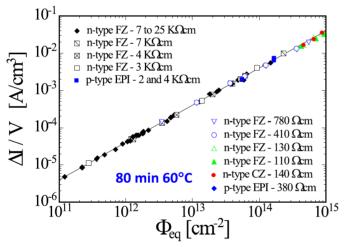
- Radiation tolerance of HV-MAPS last evaluated in context of a possible usage in the ATLAS upgrade
- HV-MAPS technology is the baseline design choice for LHCb's Upgrade 2 Mighty Tracker¹
- → Requirements on HV-MAPS technology
 - 99 % detection efficiency within 25 ns (bunch crossing)
 - Radiation tolerance up to $3 \times 10^{14} \, n_{eq}/cm^2$
 - Noise rate < 400 kHz/cm²

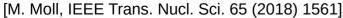


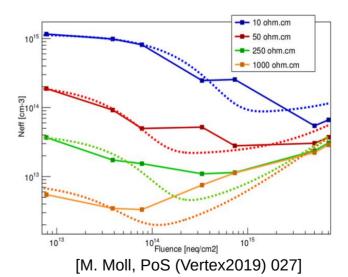
[A. Herkert, PhD Thesis 2020 Heidelberg²]

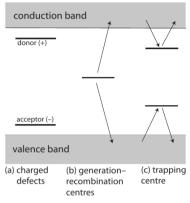
Expected Radiation Effects

- Increase in leakage due to defect energy levels
 - → Higher noise level
- Change in substrate resistivity ρ due to acceptor removal
 - \rightarrow Depletion zone changes $d \sim \sqrt{\rho_{material} V_{bias}}$



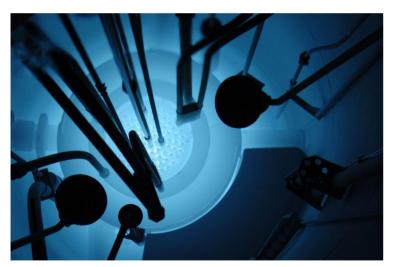






[Kolanoski & Wermes, Particle Detectors 2022]

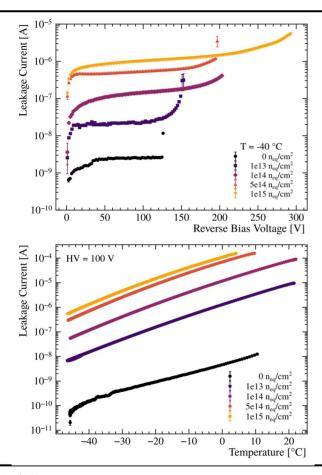
- TelePix2 irradiation in the TRIGA reactors at JGU Mainz³ and JSI Ljubljana⁴
- Annealing after irradiation at 60°C for 120 mins



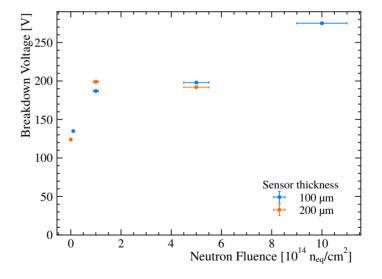
[Triga JGU Mainz]

NIEL [n _{eq} /cm²]	Irradiation Facility	Sensor Thickness [µm]
0	-	200
1e13	JSI Ljubljana	100
1e14	JSI Ljubljana	100
1e14	JGU Mainz	200
5e14	JSI Ljubljana	100
5e14	JGU Mainz	200
1e15	JSI Ljubljana	100

IV - Characteristics

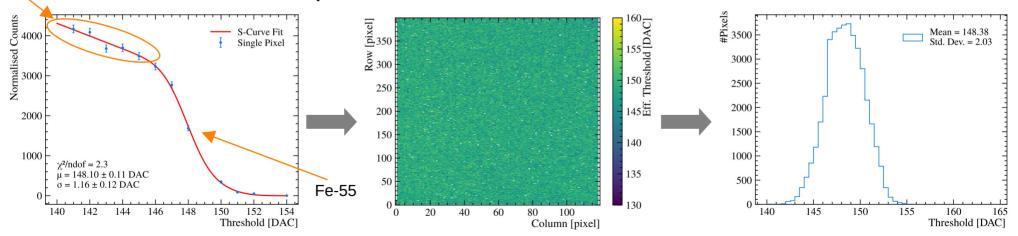


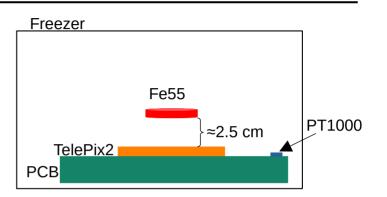
- Leakage increases with radiation damage due to defects
- Cooling needed to keep noise from leakage manageable
- Observe increasing breakdown voltage
 - → Change in effective doping affects biasing structure



Signal Response after Irradiation

- Using x-ray from Fe-55 (5.9 keV) to gauge signal response after irradiation
- PCB cooled to -35°C
- Reverse bias of 130 V
- S-curve measurement for every pixel
- Extract effective threshold μ and noise σ

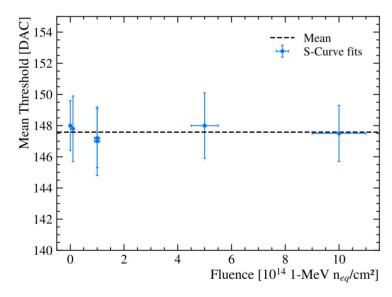


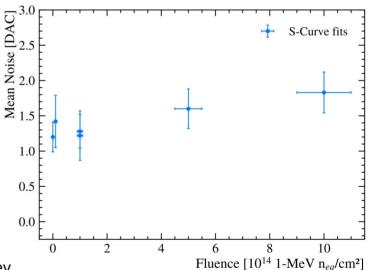


Charge sharing

Signal Response after Irradiation

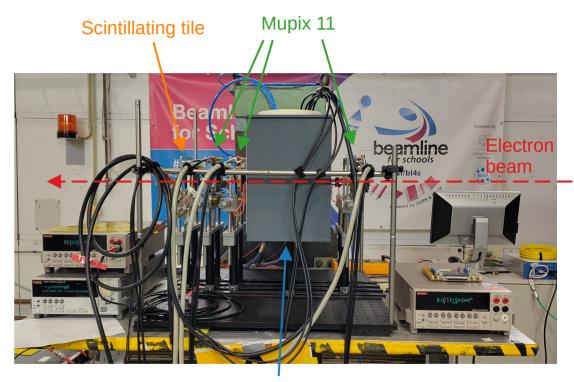
- Effective threshold μ not affected by neutron irradiation
- Mean across all samples: 148 DAC ≈ 1600 e
- No threshold calibration due to non-linearity of CSA
- Noise σ increases with radiation damage





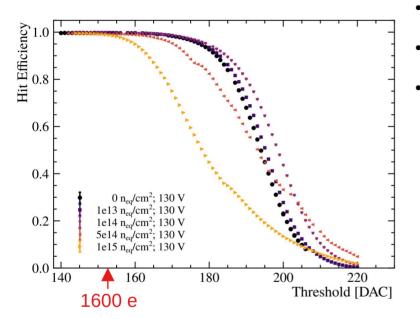
Error bars denote std.dev.

- Test beam evaluation @ DESY⁵
 - 4 GeV electrons
 - Goal: hit efficiency & time resolution
- Reference system
 - Track reconstruction: 3 layers of **Mupix11** ($\sigma_x \approx 23 \mu m$)
 - Timing: Scintillating tile (σ_t < 1 ns)
- TelePix2 in cold box with dry ice and fans
 - Monitoring with PT1000 on chip carrier PCB
 - PCB temp. between -10°C and -45°C
- Data analysed with Corryvreckan⁶



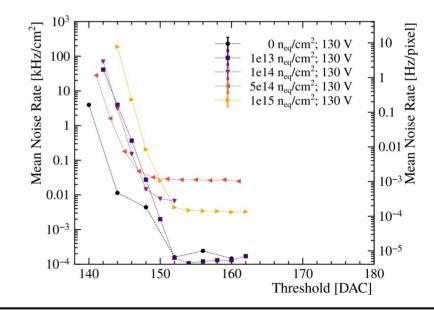
Cold box with TelePix2

Hit Efficiency at Nominal Bias



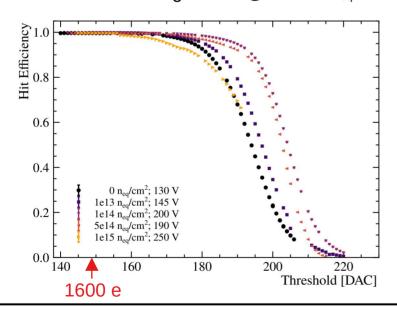
- Temperatures between -25°C and -35°C (PCB)
- · Masked pixel are included in hit efficiency

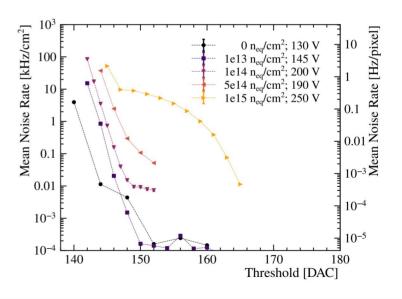
- **99% hit efficiency** at noise ≈ 0.01 Hz/pixel for **all** irradiated samples
- Noise rate measured with beam off @ < 1 % masked pixels
- Larger $\epsilon > 99\%$ plateau for 1×10^{13} and 1×10^{14} n_{eq}/cm² \rightarrow Compatible with a change of substrate resistivity



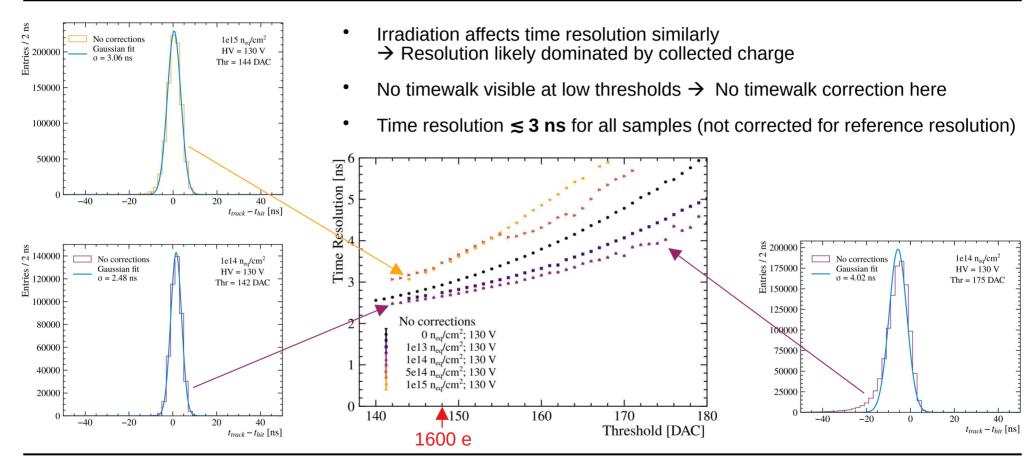
Hit Efficiency at Maximum Bias

- Higher breakdown voltage for higher neutron fluence
 → Allows to recover performance for the higher irradiated samples
- 99 % hit efficiency at a noise rate ≈ 0.5 Hz/pixel
- Observe increased noise rate for higher reverse bias voltage
 - \rightarrow Need more cooling: -10°C @ 1×10¹³ n_{eq}/cm² to -45°C @ 1×10¹⁵ n_{eq}/cm²





Time Resolution at Nominal Bias

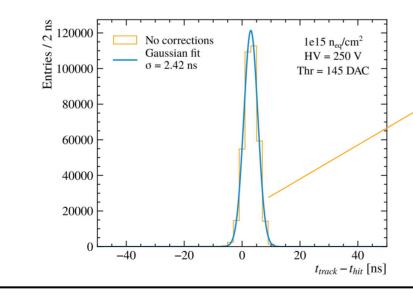


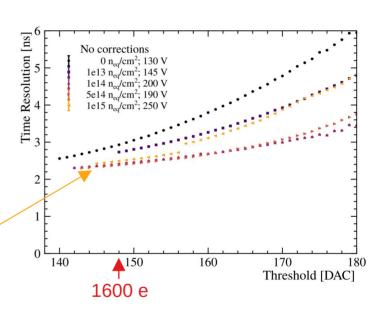
Time Resolution at Maximum Bias

Increasing bias voltage improves time resolution

→ All irradiated samples achieve **better** time resolution than reference sample

• After 1×10^{15} n_{eq}/cm²: $\sigma_t < 2.42$ ns (not corrected for reference resolution)



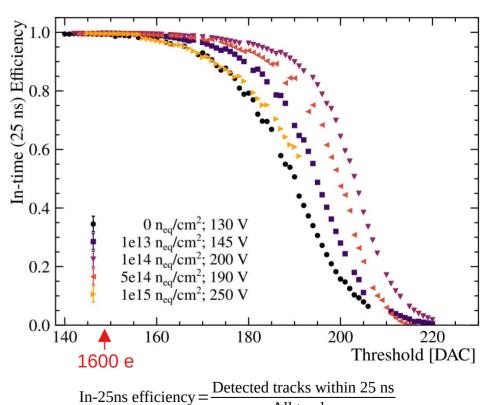


In-25ns Efficiency

LHCb Mighty Tracker:

- NIEL = $3 \times 10^{14} \, n_{eg}/cm^2$
- In-25ns efficiency > 99 %
- Noise rate < 400 kHz/cm²

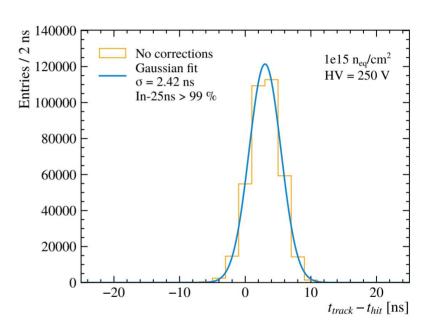
- In-25 ns efficiency is the important quantity for LHCb
- 99 % in-25ns efficiency up to 1×10^{15} n_{eq}/cm²
- Noise rate below 100 kHz/cm² for all samples
- Radiation tolerance of HV-MAPS technology is **sufficient** to be employed in the LHCb Upgrade 2 Mighty Tracker



All tracks

Summary

- Effective threshold not affect by neutron radiation damage
- TelePix2 is radiation tolerant up to 1×10^{15} n_{eq}/cm²
 - Hit efficiency > 99 %
 - Time resolution < 2.4 ns
- HV-MAPS technology is sufficiently tolerant to neutron radiation for use cases such as LHCb Upgrade 2



We thank the TRIGA reactor teams of JSI Ljubljana and JGU Mainz for their support irradiating the samples.

The measurements leading to these results have been performed at the Test Beam Facility at DESY Hamburg (Germany), a member of the Helmholtz Association (HGF).

Back-up

Test Beam Temperatures

Fluence	Temperature @ HV = 130 V	Temperature @ max. HV
0	-25 °C	-
$1 \times 10^{13} \text{ n}_{eq}/\text{cm}^2$	-25 °C	-10 °C
$1 \times 10^{14} \text{ n}_{eq}/\text{cm}^2$	-30 °C	-30 °C
$5 \times 10^{14} n_{eq}/cm^2$	-30 °C	-40 °C
$1 \times 10^{15} \text{ n}_{eq}/\text{cm}^2$	-35 °C	-45 °C

PCB temperature

A Test Beam Telescope

Scintillators:

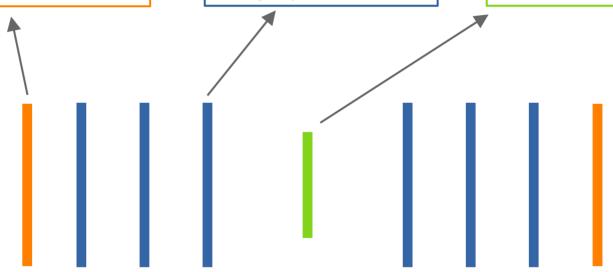
- Produce trigger
- Good time resolution
- No spatial information

Monolithic pixel sensors:

- Triggered readout
- No time information
- High spatial resolution

Device under test:

- Different size
- Different readout frame
- ...



Case 1: Small DUT

Scintillators:

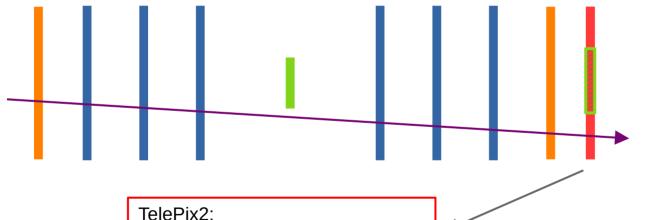
- Produce trigger
- Good time resolution
- No spatial information

Monolithic Pixel Sensors:

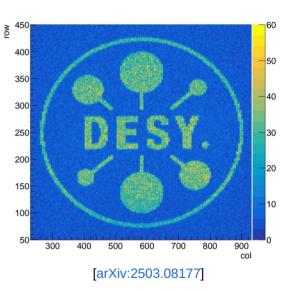
- Triggered readout
- No time information
- High spatial resolution

Device Under Test:

- Different size
- Different readout frame



- User configurable trigger output
- → Efficient data taking



Hits in telescope layer triggered by TelePix2

Case 2: Multiple Particles

Scintillators:

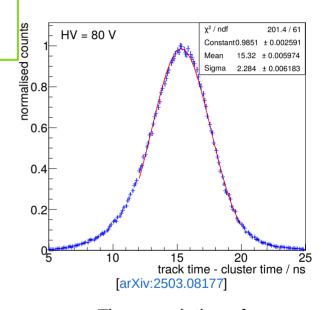
- Produce trigger
- Good time resolution
- No spatial information

Monolithic Pixel Sensors:

- Triggered readout
- No time information
- High spatial resolution

Device Under Test:

- Different size
- Different readout frame
- ...



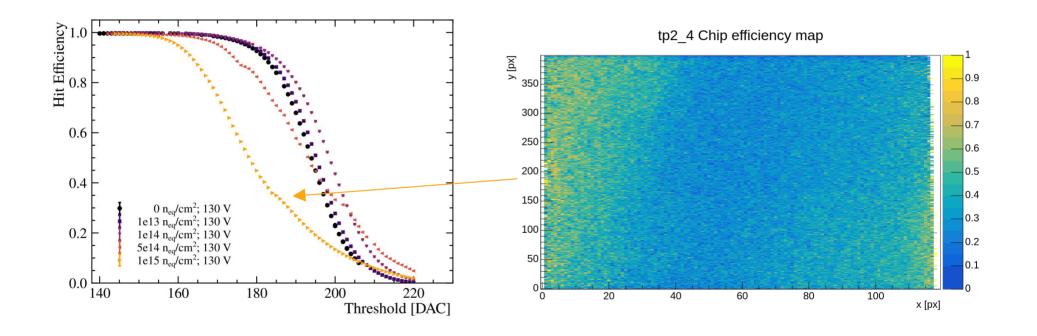
Time resolution of TelePix2's trigger output

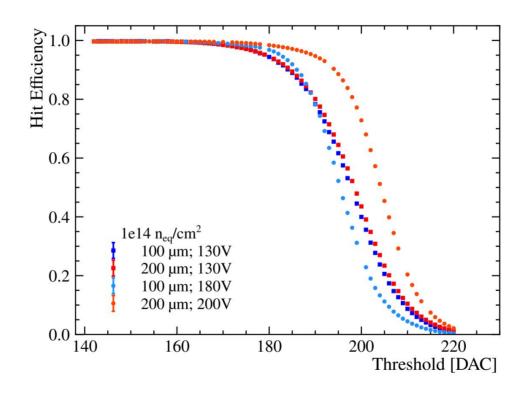
 σ = 2.284 ns



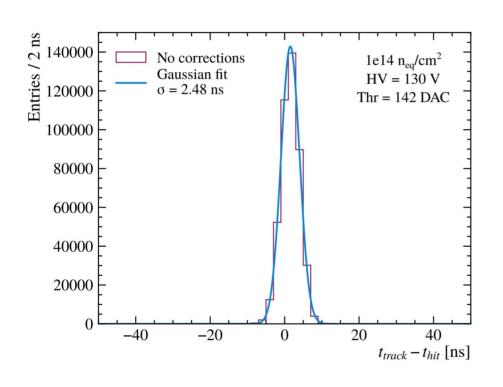
- O(10 μm) spatial resolution
- O(ns) time resolution
- → Solves ambiguities

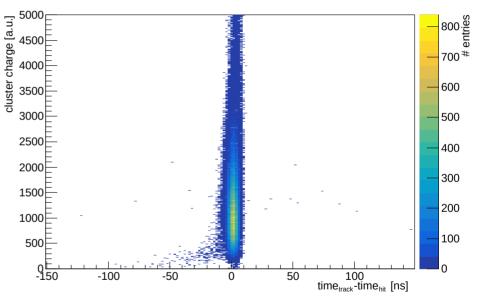
Hit Efficiency at 130 V



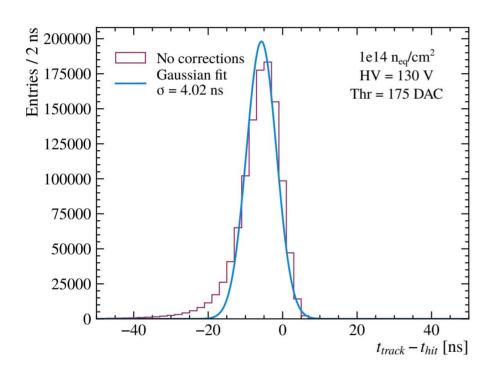


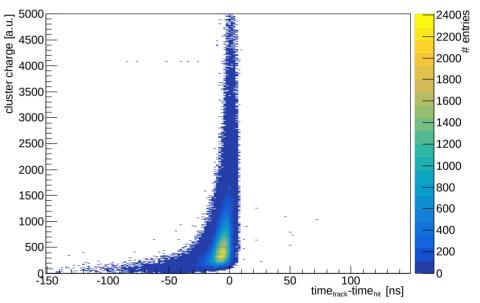
Timewalk

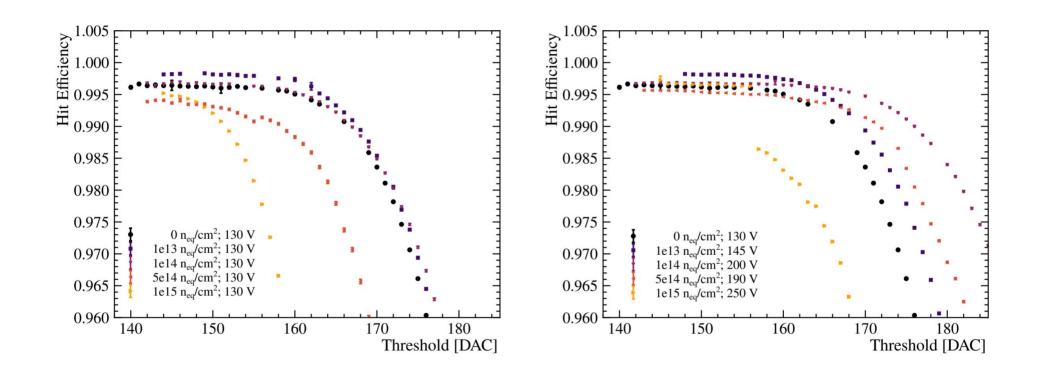




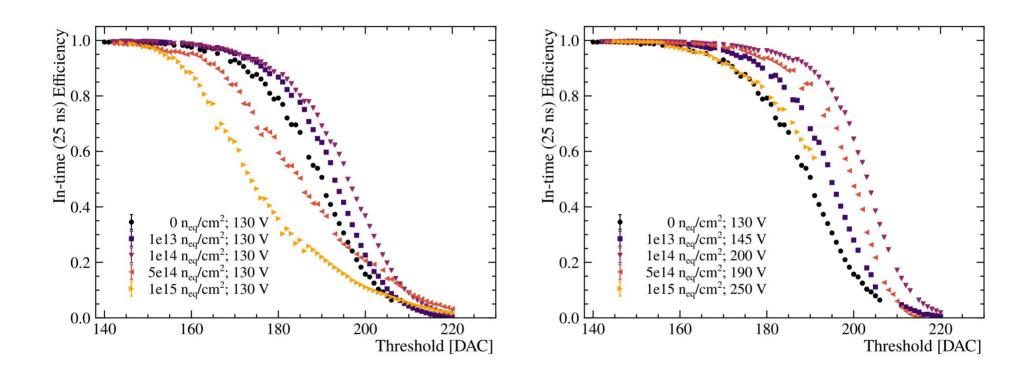
Timewalk







In-25ns Efficiency



Reactor Validation

Measured vs Simulated Fluence

